Lanto Electronic Ltd

No.399 baisheng Road, jinxi Town, Kunshan, Jiangsu, China 215234 Tel: +86 512 8269 8999 ; Fax: +86 512 50362802

Date: April 6, 2022

Innovation, Science and Economic Development Canada Certification & Engineering Bureau P.O. Box 11490, Station H 3701 Carling Ave., Building 94 Ottawa, Ontario K2H 8S2

SUBJECT: Re-assessment

The intention of this application is to enable the modular IC: 23965-HSNL01NFM, HVIN: HSN-L01NFM, approved on 04/04/2022 to be integrated in HP Notebook Computer, HSN-I55C.

The module installed into host platform mentioned above is electronically and mechanically identical to the original certified module. The Original testing on module under IC: **23965-HSNL01NFM** was performed with an antenna was connected to the module in an open environment. The current host platform under application uses the same type and is installed inside the host platform enclosure. The physical restraints introduced by the host platform should have resulted in equal or lower level of radiated emission. Therefore, additional Radiated emission testing is not necessary.

Sincerely yours,

Zeresa wing

Teresa Wang Teresa.W@luxshare-ict.com